

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>CHARLES M. LIEBER</td> <td>09/18/2013</td> </tr> <tr> <td>BOZHI TIAN</td> <td>10/02/2013</td> </tr> <tr> <td>JIA LIU</td> <td>09/18/2013</td> </tr> </tbody> </table>		Name	Execution Date	CHARLES M. LIEBER	09/18/2013	BOZHI TIAN	10/02/2013	JIA LIU	09/18/2013		
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>PRESIDENT AND FELLOWS OF HARVARD COLLEGE</td> </tr> <tr> <td>Street Address:</td> <td>17 QUINCY STREET</td> </tr> <tr> <td>City:</td> <td>CAMBRIDGE</td> </tr> <tr> <td>State/Country:</td> <td>MASSACHUSETTS</td> </tr> <tr> <td>Postal Code:</td> <td>02138</td> </tr> </table>		Name:	PRESIDENT AND FELLOWS OF HARVARD COLLEGE	Street Address:	17 QUINCY STREET	City:	CAMBRIDGE	State/Country:	MASSACHUSETTS	Postal Code:	02138
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CORRESPONDENCE DATA											
Fax Number: (617)646-8646 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 617-646-8000 Email: patents_timo@wolfgreenfield.com Correspondent Name: WOLF, GREENFIELD & SACKS, P.C. Address Line 1: 600 ATLANTIC AVENUE Address Line 4: BOSTON, MASSACHUSETTS 02210											
ATTORNEY DOCKET NUMBER:	H0498.70435US02										
NAME OF SUBMITTER:	EILEEN M. MACKENZIE										
Signature:	/Eileen M. MacKenzie/										
Date:	10/03/2013										

OP \$40.00 14018075

Total Attachments: 10

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ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we, the undersigned:

Charles M. Lieber, Bozhi Tian and Jia Liu

(each hereafter "Assignor") hereby assign, sell, and transfer to:

**President and Fellows of Harvard College
17 Quincy Street, Cambridge, Massachusetts 02138**

(hereafter "Assignee") its successors and assigns, Assignor's entire right, title, and interest throughout the world in and to any and all inventions for:

METHODS AND SYSTEMS FOR SCAFFOLDS COMPRISING NANOELECTRONIC COMPONENTS

described in **U.S. Patent Application No. 14/018,075**, filed **September 4, 2013**, and in and to the aforesaid application, in any form or embodiment thereof, and in and to any application on any of the inventions filed in this and any foreign country, based thereon, including the right to file said applications, apply for patent rights, and claim priority under the provisions of any international convention or treaty; also the entire right, title, and interest throughout the world in and to any and all patents or reissues or extensions thereof to be obtained in this or any foreign country upon any of the inventions and any divisional, continuation, or substitute applications which may be filed upon said invention or inventions in this or any foreign country; and the right to sue in its own name and recover damages for past infringement of any United States Letters Patent and foreign patent; and authorize and request the issuing authority to issue any and all patents on said application or applications to said Assignee or its successors and assigns.

For purposes of complying with foreign requirements, the above paragraph is intended to expressly grant all the recited rights and grants in China, Korea, and Japan.

Assignor hereby warrants that he/she has full right to convey his/her entire right, title and interest, both legal and equitable, in and to said inventions, free from all prior

Patent Assignment
HU Case No.: HU 4370 (Lieber)
Appln. No.: 14/018,075
WGS File No.: H0498.70435US02

assignments, agreements, licenses, mortgages, security interests, or other encumbrances whatsoever; and

Assignor further agrees, without further payment or compensation by said Assignee, or its successors and assigns, to communicate to said Assignee, its representatives or agents, or its successors and assigns, any facts relating to said invention or inventions including evidence for interference purposes or for other legal proceedings, whenever requested; testify in any interference or other legal proceedings whenever requested; execute and deliver, on request, all lawful papers required to make any of the foregoing provisions effective; and generally do everything possible to aid said Assignee, its representatives or agents, or its successors or assigns to secure, obtain, and enforce proper patent protection for said invention or inventions in this and any foreign country.

Assignor authorizes Assignee or Assignee's representative to supply and/or to correct any errors in the patent/application information provided above including, but not limited to, said application serial number and filing date, prior to or after recordation.

Assignor appoints Assignee, through its designee, as its attorney-in-fact to execute, in Assignor's name and on Assignor's behalf, any and all documents required to effectuate this Assignment, specifically including, but not limited to, those documents specified above and any necessary corrective assignments.

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9/18/2013
Date

Charles M. Lieber
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Citizenship: US

Witness:

18 Sept 2013
Date

Renee Donlon
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Cambridge, MA 02138

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Date

Inventor: Bozhi Tian

Address: 5314 S Ingleside Ave.

Chicago, Illinois 60615

Citizenship: People's Republic of China

Witness:

Date

Signature

Name: _____

Address: _____

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Date


Inventor: Jia Liu

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Somerville, Massachusetts 02143

Citizenship: People's Republic of China

Witness:

18 Sept 13

Date


Signature

Name: Renée Donlon

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Cambridge, MA 02138

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Assignor further agrees, without further payment or compensation by said Assignee, or its successors and assigns, to communicate to said Assignee, its representatives or agents, or its successors and assigns, any facts relating to said invention or inventions including evidence for interference purposes or for other legal proceedings, whenever requested; testify in any interference or other legal proceedings whenever requested; execute and deliver, on request, all lawful papers required to make any of the foregoing provisions effective; and generally do everything possible to aid said Assignee, its representatives or agents, or its successors or assigns to secure, obtain, and enforce proper patent protection for said invention or inventions in this and any foreign country.

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